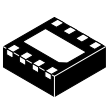
CM1407

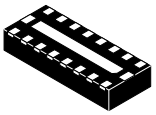
4 and 8-Channel EMI Filter Arrays with ESD Protection

ON Semiconductor®

http://onsemi.com



WDFN8
DF/DE SUFFIX
CASE 511BE



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DF/DE SUFFIX
CASE 511AU

Product Description

ON Semiconductor CM1407 is an EMI filter array with ESD protection, which integrates either four or eight pi filters (C−R−C). The CM1407 has component values of 7.5 pF − 200 Ω − 7.5 pF (f_C = 210 MHz). The parts include ESD protection diodes on every pin, providing a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports safely dissipate ESD strikes of ±15 kV contact discharge, twice the specification requirement of the IEC 61000−4−2, Level 4 international standard. Using the MIL−STD−883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±30 kV.

This device is particularly well−suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package and easy−to−use pin assignments. In particular, the CM1407 is ideal for EMI filtering and protecting data lines from ESD in wireless handsets.

The CM1407 is available in space−saving, low−profile, 8 and 16−lead WDFN packages. It is fabricated with ON Semiconductor's *Centurion*™ process and available with optional lead−free finishing.

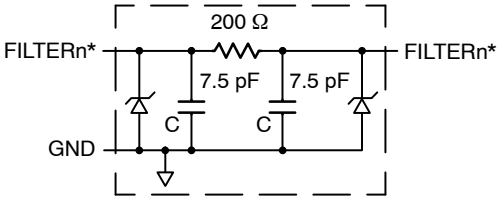
Features

- Four and Eight Channels of EMI Filtering with ESD Protection
- Greater than 25 dB of Attenuation from 800 Mhz to 3 GHz
- ±15 kV ESD Protection (IEC 61000−4−2, Contact Discharge)
- ±30 kV ESD Protection (MIL−STD−883, Method 3015, HBM)
- Fabricated with *Centurion*™ Advanced Low Capacitance Zener Process Technology
- Space Saving, Low Profile 8 and 16−lead 0.5 mm Pitch WDFN Packages
- These Devices are Pb−Free and are RoHS Compliant

Applications

- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers
- EMI Filtering for LCD, Camera and Chip−to−Chip Data Lines

BLOCK DIAGRAM



1 of 4/8 EMI Filtering + ESD Channels

*See Package/Pinout Diagrams for Expanded Pin Information.

MARKING DIAGRAM





N07 4X = Specific Device Code
N78X = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping†
CM1407−04DF	WDFN8 (Pb−Free)	3000/Tape & Reel
CM1407−08DF	WDFN16 (Pb−Free)	3000/Tape & Reel
CM1407−04DE	WDFN8 (Pb−Free)	3000/Tape & Reel
CM1407−08DE	WDFN16 (Pb−Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

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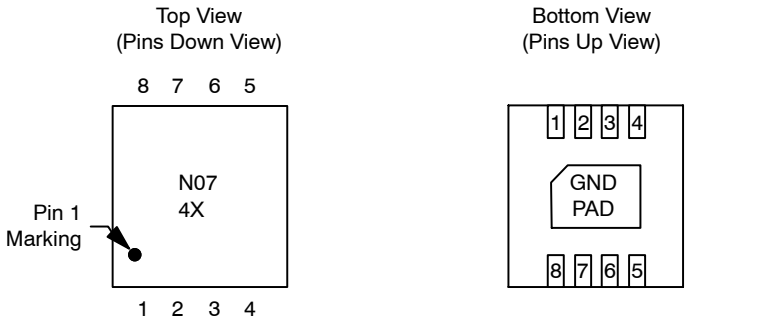
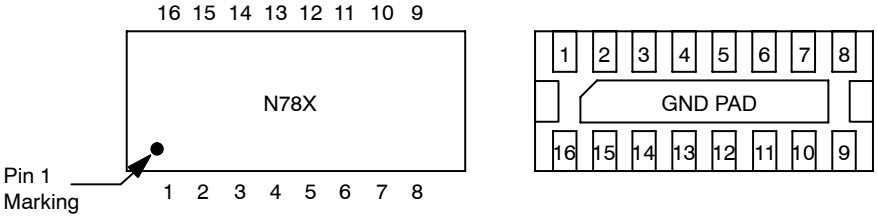
PACKAGE / PINOUT DIAGRAMS

CM1407−04DE/DF
8−Lead WDFN Package



CM1407−08DE/DF
16−Lead WDFN Package
with Exposed End Pads



Note: See Ordering Information section for device specific marking.

Table 1. PIN DESCRIPTIONS

Pins				Pins			
1406−04Dx	**1406−08Dx**	**Name**	**Description**	**1406−04Dx**	**1406−08Dx**	**Name**	**Description**
1	1	FILTER1	Filter Channel 1	8	16	FILTER1	Filter Channel 1
2	2	FILTER2	Filter Channel 2	7	15	FILTER2	Filter Channel 2
3	3	FILTER3	Filter Channel 3	6	14	FILTER3	Filter Channel 3
4	4	FILTER4	Filter Channel 4	5	13	FILTER4	Filter Channel 4
	5	FILTER5	Filter Channel 5		12	FILTER5	Filter Channel 5
	6	FILTER6	Filter Channel 6		11	FILTER6	Filter Channel 6
	7	FILTER7	Filter Channel 7		10	FILTER7	Filter Channel 7
	8	FILTER8	Filter Channel 8		9	FILTER8	Filter Channel 8
GND Pad		GND	Device Ground				

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Storage Temperature Range	−65 to +150	°C
DC Power per Resistor	100	mW
Package DC Power Rating	300	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	−40 to +85	°C

Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
R	Resistance		160	200	240	Ω
C	Capacitance	At 2.5 V DC, 1 MHz, 30 mV AC	6	7.5	9	pF
V_{DIODE}	Diode Standoff Voltage	I_{DIODE} = 10 μA		6.0		V
I_{LEAK}	Diode Leakage Current (Reverse Bias)	V_{DIODE} = 3.3 V		0.1	1	μA
V_{SIG}	Signal Voltage Positive Clamp Negative Clamp	 I_{LOAD} = 10 mA I_{LOAD} = −10 mA	 5.6 −1.5	 6.8 −0.8	 9.0 −0.4	V
V_{ESD}	In−system ESD Withstand Voltage a) Human Body Model, MIL−STD−883, Method 3015 b) Contact Discharge per IEC 61000−4−2 Level 4	(Note 2)	 30 15			kV

1. T_A = 25°C unless otherwise specified.
2. ESD applied to input and output pins with respect to GND, one at a time.

PERFORMANCE INFORMATION

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

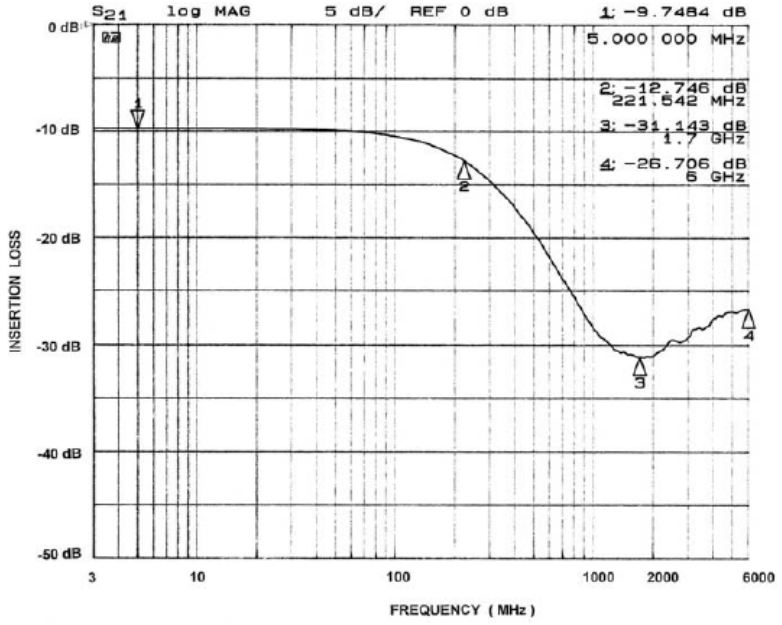


Figure 1. Channel 1 EMI Filter Performance (CM1407−04)

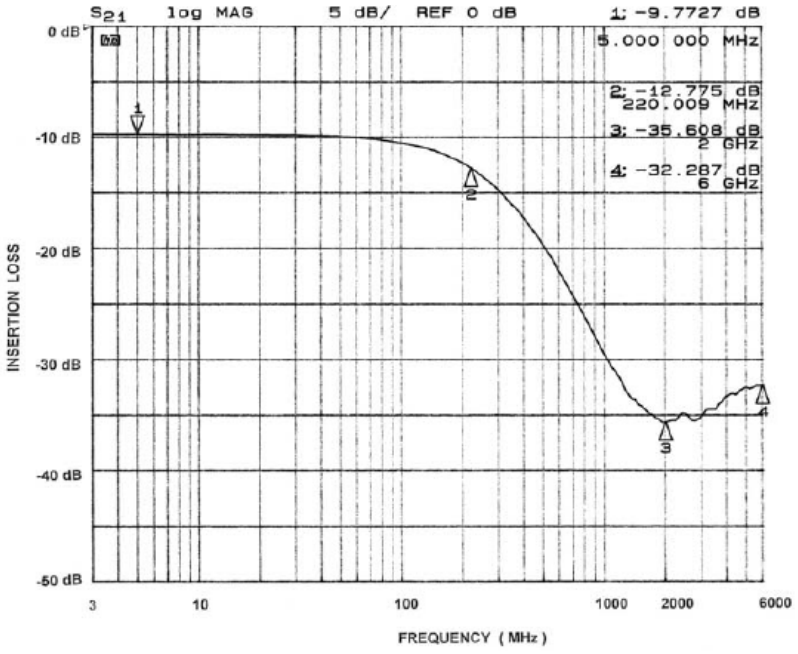


Figure 2. Channel 2 EMI Filter Performance (CM1407−04)

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

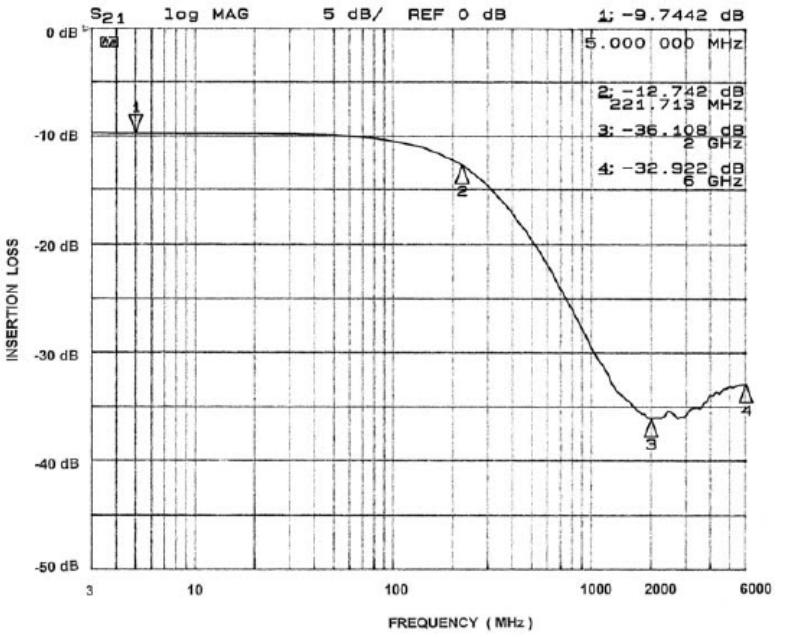


Figure 3. Channel 3 EMI Filter Performance (CM1407−04)

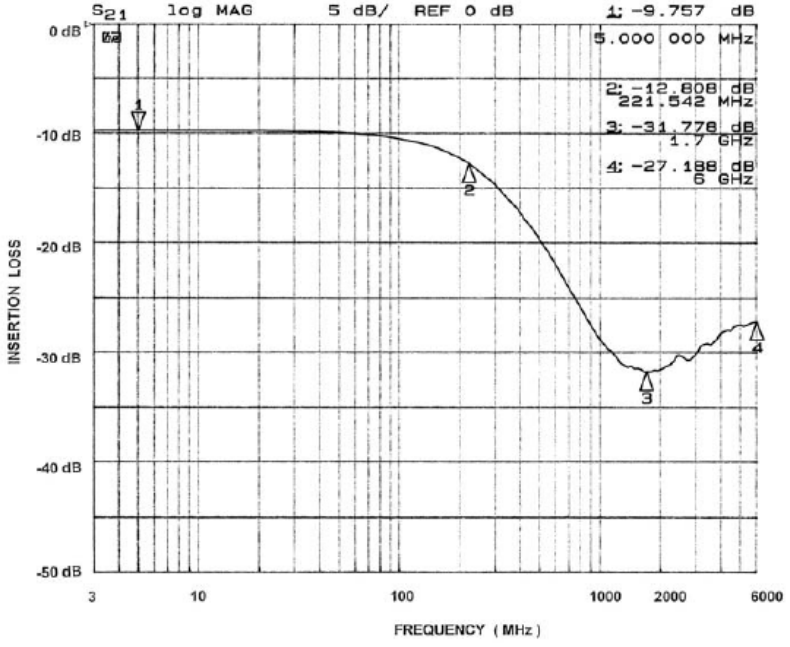


Figure 4. Channel 4 EMI Filter Performance (CM1407−04)

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

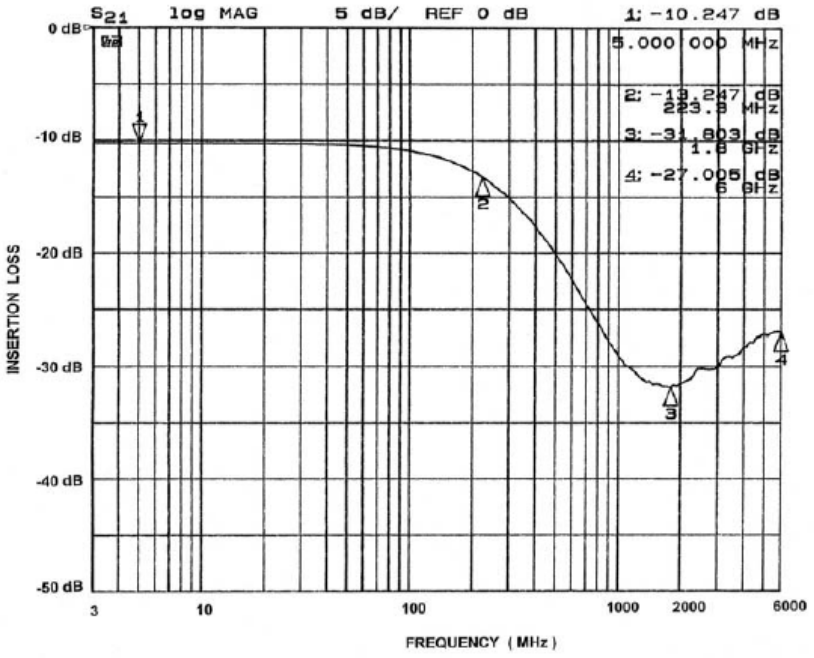


Figure 5. Channel 1 EMI Filter Performance (CM1407−08)

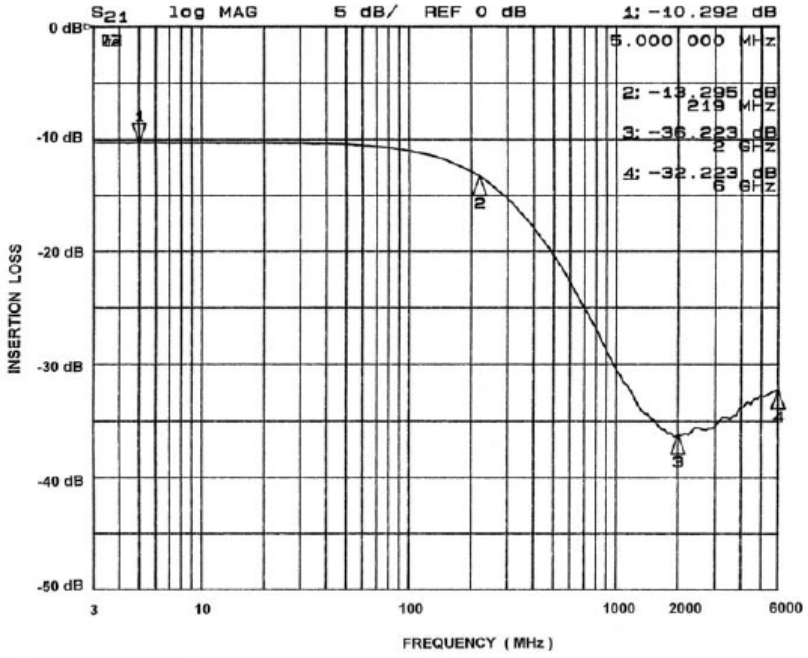


Figure 6. Channel 2 EMI Filter Performance (CM1407−08)

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

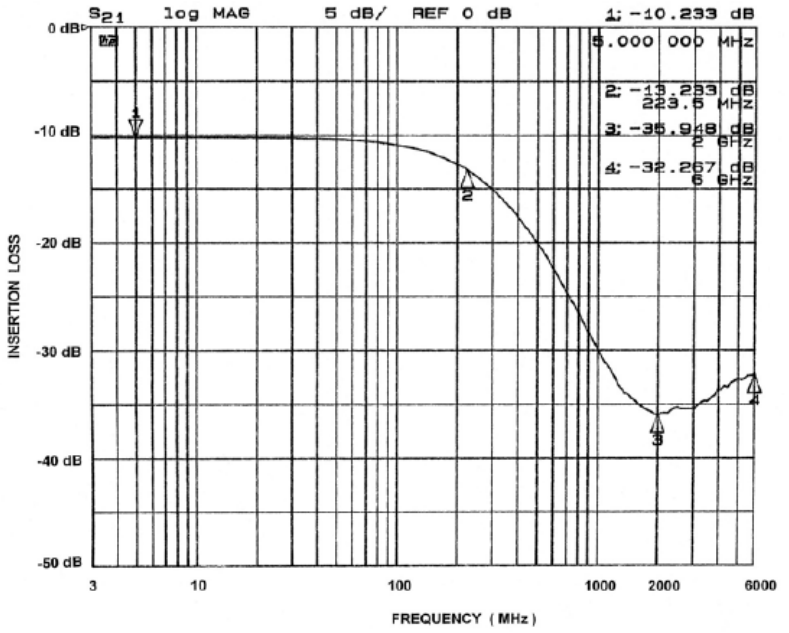


Figure 7. Channel 3 EMI Filter Performance (CM1407−08)

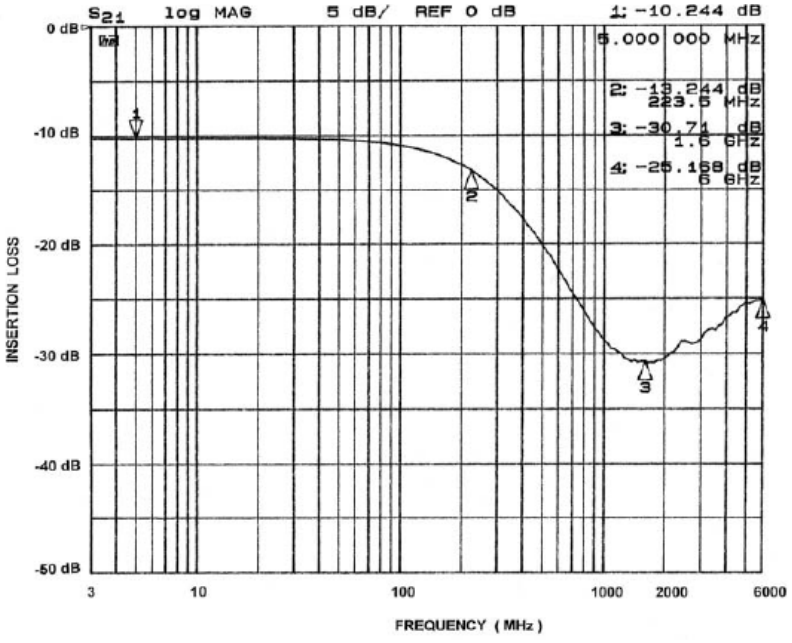


Figure 8. Channel 4 EMI Filter Performance (CM1407−08)

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

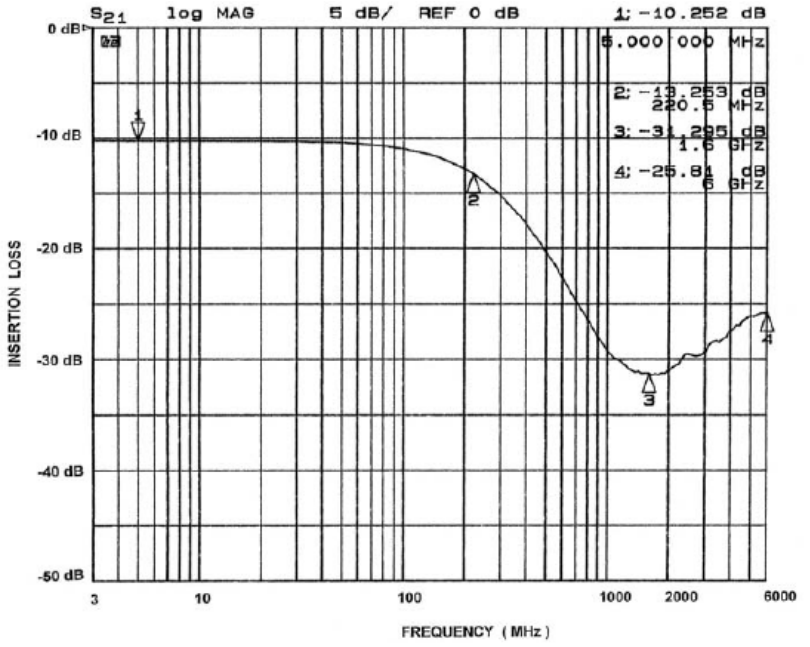


Figure 9. Channel 5 EMI Filter Performance (CM1407−08)

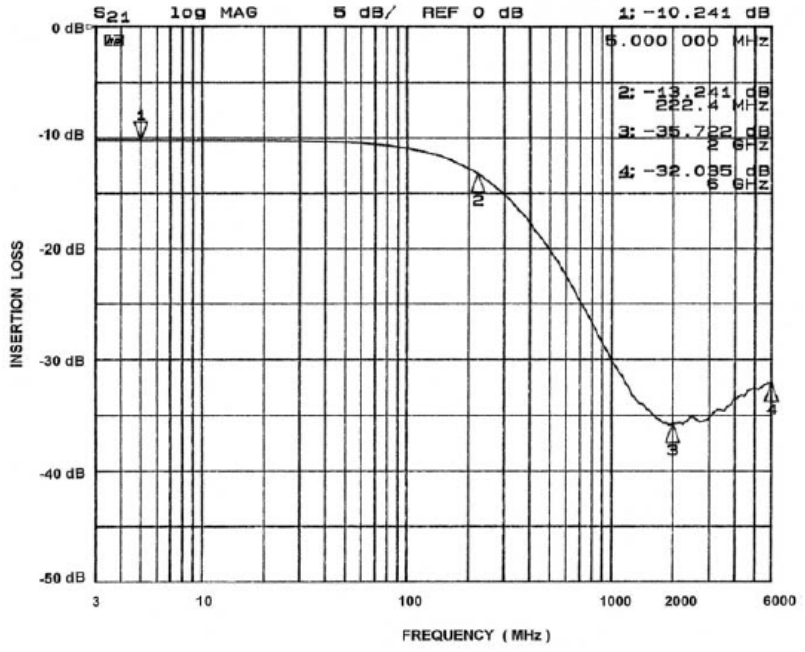


Figure 10. Channel 6 EMI Filter Performance (CM1407−08)

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 0 V DC Bias, 50 Ω Environment)

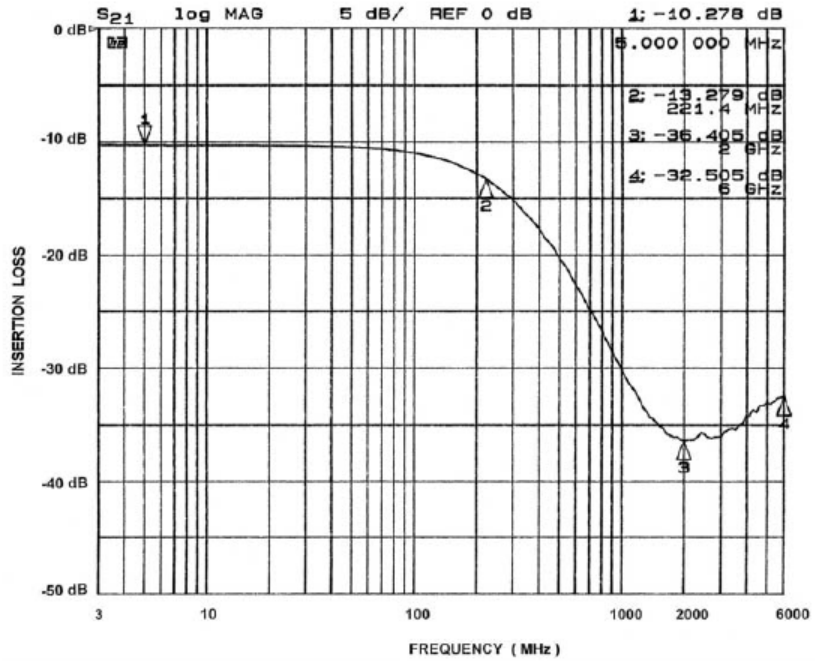


Figure 11. Channel 7 EMI Filter Performance (CM1407−08)

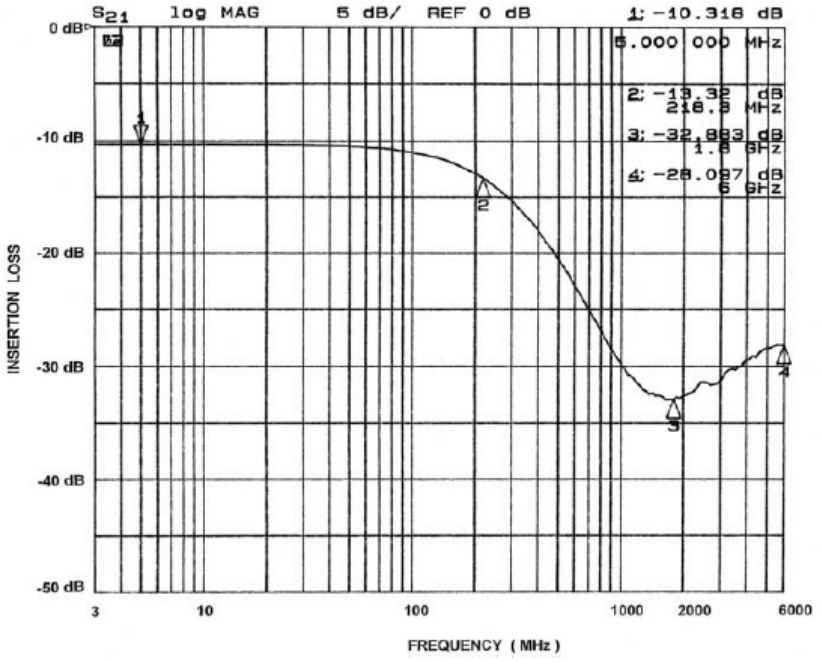


Figure 12. Channel 8 EMI Filter Performance (CM1407−08)

PERFORMANCE INFORMATION (Cont'd)

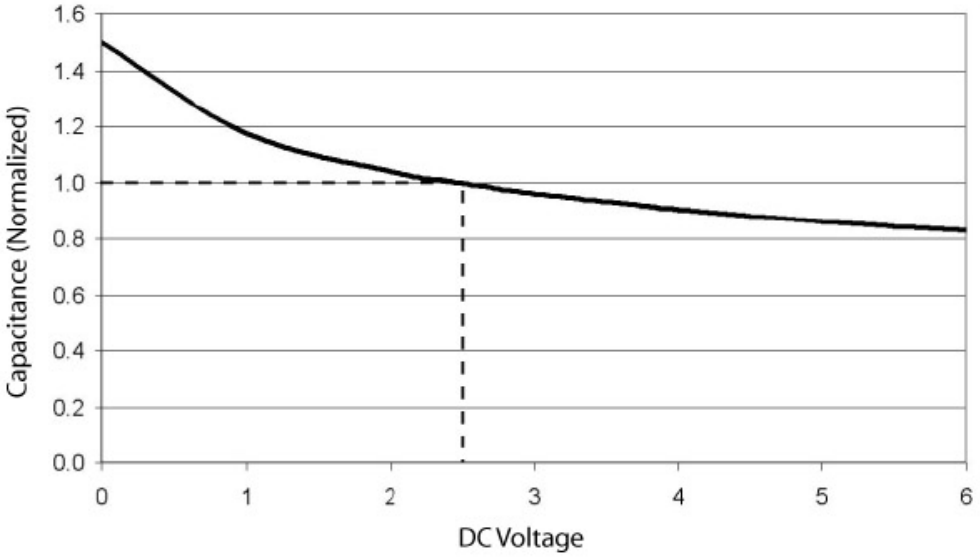


Figure 13. Filter Capacitance vs. Input Voltage over Temperature (normalized to capacitance at 2.5 V DC and 25°C)

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WDFN16, 4x1.6, 0.5P
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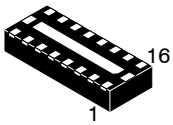
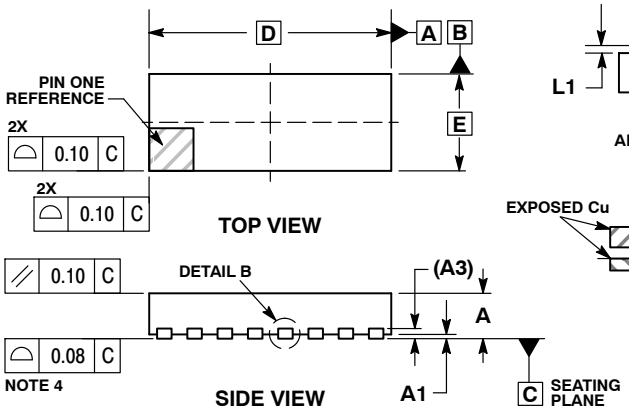
ISSUE O

DATE 06 JUL 2010

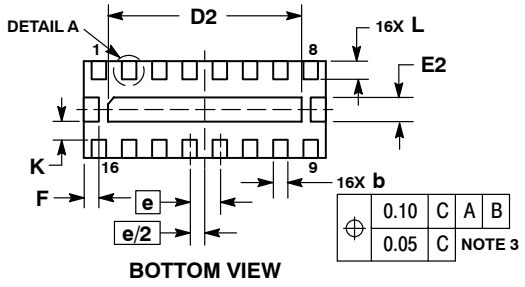


SCALE 4:1

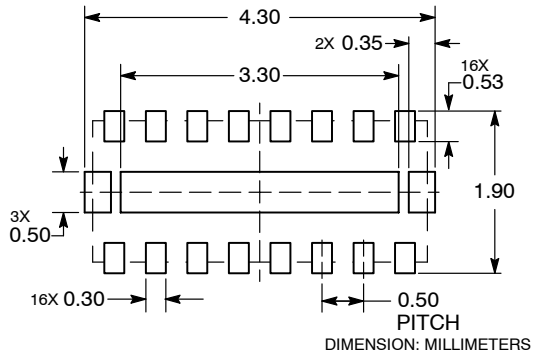


NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS	
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.20	0.30
D	4.00 BSC	
D2	3.10	3.30
E	1.60 BSC	
E2	0.30	0.50
e	0.50 BSC	
F	0.25 REF	
K	0.30 REF	
L	0.20	0.40
L1	---	0.15



RECOMMENDED SOLDERING FOOTPRINT*



DIMENSION: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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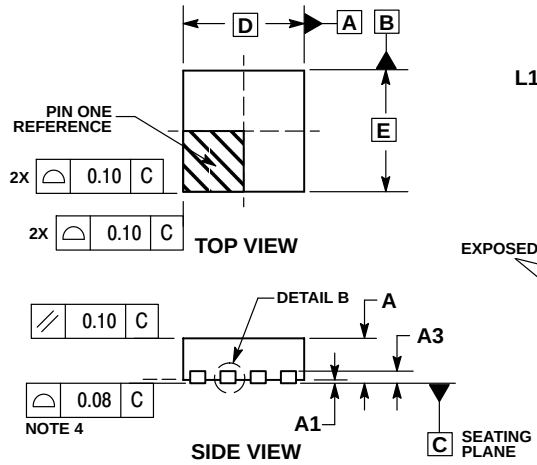

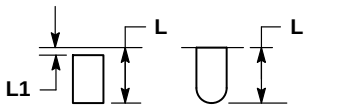

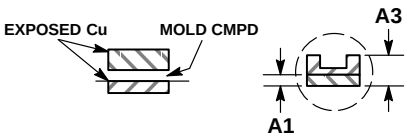

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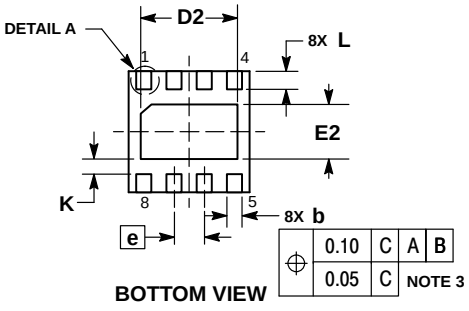
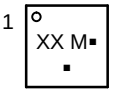
DIM	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.20	0.30
D	2.00 BSC	
D2	1.50	1.70
E	2.00 BSC	
E2	0.80	1.00
e	0.50 BSC	
K	0.25 REF	
L	0.20	0.40
L1	−−−	0.15



GENERIC MARKING DIAGRAM*

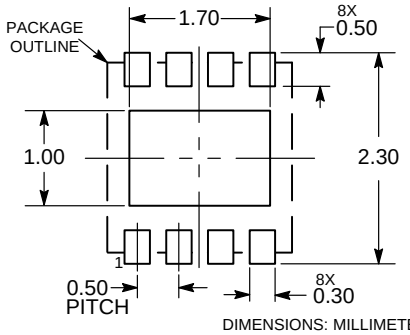


XX = Specific Device Code
M = Date Code
▪ = Pb−Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present.

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb−Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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